

SMT DIL OCXO

Stratum 3E

FEATURES

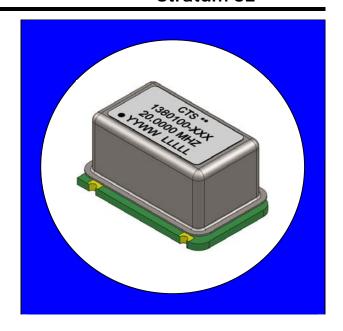
- Compliant to Stratum 3E of GR-1244-CORE
- Surface Mount Dual-In-Line Package
- 20 MHz
- 3.3V operation
- Low Jitter/Phase Noise
- Tape and Reel Packaging
- Fully compliant to RoHS Directive 2002/95/EC

DESCRIPTION

The CTS model 1380100 is a low cost, small size, high performance OCXO. The high quality CTS Quartz Crystal used in this OCXO offers high stability and low jitter/phase noise, making it the ideal choice for any telecommunications system.

Applications: Telecom Switching Wireless Communication

Timing over Packet



ELECTRICAL SPECIFICATIONS

Parameter	Conditions & Remarks	Min	Typical	Max	Unit
Operating Conditions					
Operating Temperature Range	T _{OP}	-40	-	+85	°C
Supply Voltage (Vcc)	±5%	3.135	3.3	3.465	Vdc
	during warm up	-	1.8	2.5	W
Power Consumption	steady state @ 25°C	-	0.75	1.0	W
Load	Output to Ground	5	10	15	pf
Frequency Stability					
Frequency	f _{NOM}	-	20	-	MHz
Calibration	$\Delta f/f_{NOM}$; $T_A=25^{\circ}C$; at time of shipment	-	±300	± 500	ppb
vs Operating Temperature	-20°C to +70°C -40°C to +85°C	-	7	10	ppb, pk-pk
vs Supply Voltage	± 5%	-	± 1	± 2	ppb
	Per day, at time of shipment	-	±0.5	± 1	ppb/day
Aging	first year	-	-	± 100	ppb/year
	10 years	-	-	± 700	ppb/ 10years
24-Hour Holdover Stability Inclusive of operating temp and 24 hours aging drift (after 8 hours operation following 24 hours off – see Note 1)		-	-	11	ppb, pk-pk
Total Free-Run Accuracy	Under all operating conditions for 10 years	-	-	±2.5	ppm



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Parameter	Conditions & Remarks	Min	Typical	Max	Unit	
Frequency Stability	continued					
Drift	24 hours, at constant temperature (after 8 hours operation following 24 hours off – see Note 1)	-	-	±1	ppb	
	1.0 sec	-	< 0.01	0.02	ppb	
	10 sec	-	0.01	0.03	ppb	
Short Term Stability ADEV (in still air)	100 sec	-	0.02	0.05	ppb	
ADEV (III Still all)	1000 sec	-	0.05	0.1	ppb	
	10,000 sec	-	0.07	0.2	ppb	
Wander Generation	MTIE and TDEV per	MTIE and TDEV per Stratum 3E requirements of Telcordia GR-1244-CORE				
Warm-Up Time	T _A =25°C; to within 10ppb of freq. @ 30 min	-	-	5	minutes	
Phase Noise						
	10 Hz	-	-110	-	dBc/Hz	
	100 Hz	-	-130	-	dBc/Hz	
	1 kHz	-	-140	-	dBc/Hz	
	10 kHz	-	-148	-	dBc/Hz	
Spurious						
		-	-	-70	dBc	
Output Parameters				T		
Output Signal Square Wave			HCMOS			
A manufith and m	V _{OL}	-	-	10%V _{CC}	Vdc	
Amplitude	V _{OH}	90% V _{CC}	-	-	vuc	
Rise / Fall Times	10% to 90% @ 10pf load	-	3	5	ns	
Duty Cycle	@ 50 % of output signal	45	50	55	%	

Note 1: 8 hours operation required if off for 24 hours

24 hours operation required if off for up to 1 week

48 hours operation required if off for up to 1 month

Options and Part Number:

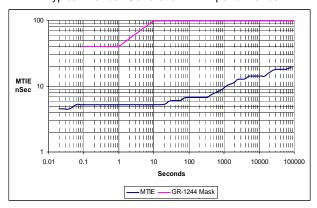
Dash No.	Package	Operating Temp. Range	Part Number
-001	Surface Mount (Fig 1)	-20°C to +70°C	1380100-001
-002	Surface Mount (Fig 1)	-40°C to +85°C	1380100-002
-003	Through-Hole (Fig 2)	-20°C to +70°C	1380100-003
-004	Through-Hole (Fig 2)	-40°C to +85°C	1380100-004



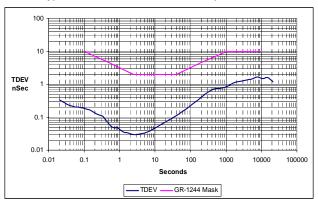
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Typical Wander Generation MTIE performance



Typical Wander Generation TDEV performance



Wander Generation and Holdover Test Report available upon request.

Mechanical and Environmental		
Soldering	Maximum reflow temperature, 245°C for 10 seconds, 240°C for 20 seconds, per IPC/JEDEC J-STD-020C	
MSL	Level 1	
RoHS	Lead-Free. Fully compliant to RoHS Directive 2002/95/EC	
Shock :	500 G's, 1msec, 5 shocks in each of 6 directions	
Sinusoidal Vibration :	10 Hz to 55 Hz with a double amplitude of 0.75mm, 10 g's peak from 55 Hz to 2000Hz, for 30 minutes in each of three perpendicular directions	
Random Vibration :	5.35 G's RMS. 20 to 500 Hz, per MIL-STD-202F, Method 214, 15 minutes each axis.	
Seal:	Hermetic	
Marking Permanency:	per MIL-STD-202F, Method 215J.	
Packaging :	Tape and Reel for Surface Mount Package; Bulk Pack in Foam for Thru-Hole Package	
Storage Temperature Range:	-40°C to +85°C	

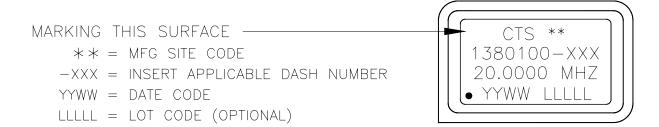


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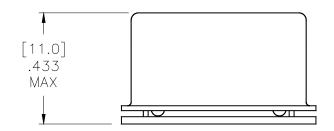
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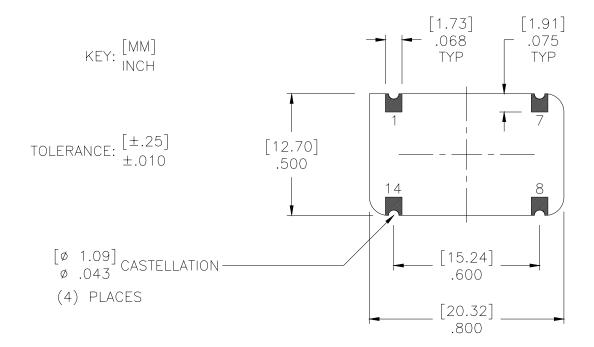
MECHANICAL SPECIFICATIONS

Figure 1 - PACKAGE DRAWING - Surface Mount



PIN / PAD	FUNCTION
1	N/C
7	OV & CASE GROUND
8	OUTPUT
14	Vcc



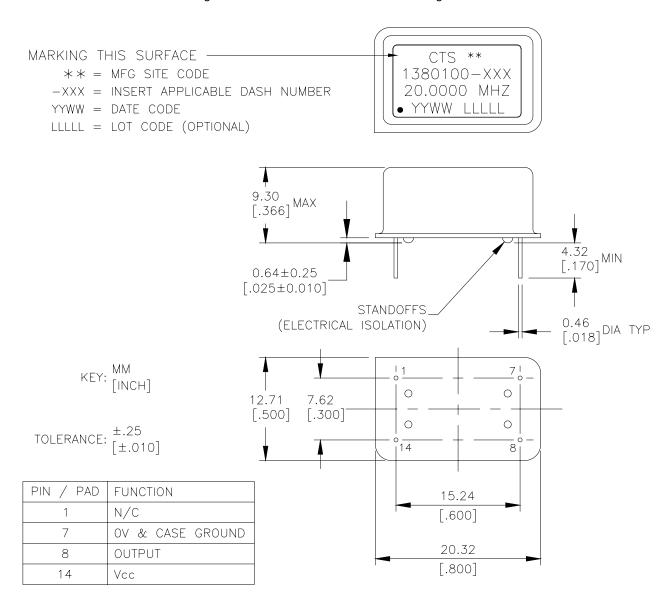




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Figure 2 - PACKAGE DRAWING - Through Hole

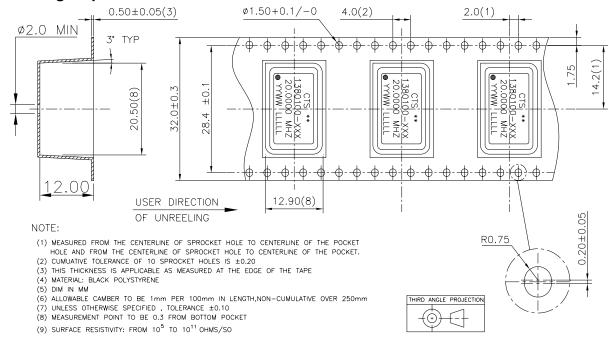


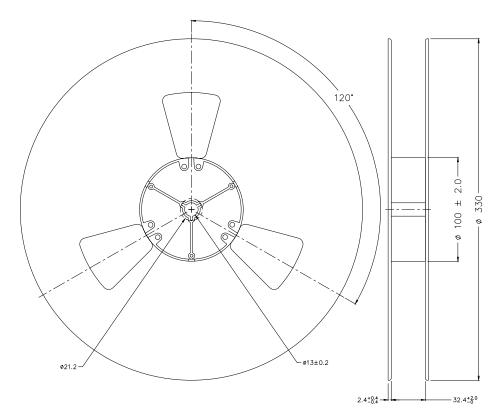


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Packing: Tape and Reel





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